

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Won Suk Lee	07/27/2011
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Property Type	Number
Application Number:	13422252
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Total Attachments: 3 source=01732239#page1.tif source=01732239#page2.tif source=01732239#page3.tif	

OP \$40.00 13422252

PATENT

ASSIGNMENT

WHEREAS, I, Won Suk LEE, of Seoul, Korea, have invented an improvement in TWO PHASE EVALUATION SCHEME FOR MULTI-WAY JOIN CONTINUOUS QUERY OVER DATA STREAMS (OP11-0136-US/SSY; WOON 8775), and have executed a provisional application for a United States patent based thereon assigned Serial No. 61/466,800, filed March 23, 2011;

AND, WHEREAS, INDUSTRY-ACADEMIC COOPERATION FOUNDATION, YONSEI UNIVERSITY, of Seoul, Korea (hereinafter referred to as "ASSIGNEE") is desirous of acquiring certain rights thereunder;

NOW, THEREFORE, for one dollar and other good and valuable consideration, receipt of all of which is hereby acknowledged, I have agreed to and do hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto in and to said invention, said United States application, any other United States applications (including provisional, non-provisional, divisional, continuing, or reissue applications) based in whole or in part on said United States application or in whole or in part on said invention, any foreign applications based in whole or in part on any of the aforesaid United States applications or in whole or in part on said invention, and any and all patents (including extensions thereof) of any country which have been or

may be granted on any of the aforesaid applications or on said invention or any part thereof;

TO BE HELD AND ENJOYED by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me had no sale and assignment of said interest been made;

AND I hereby authorize and request the Director of the United States Patent and Trademark Office of the United States of America to issue any and all United States patents which may be granted upon said United States applications or any of them, or upon said invention or any part thereof, to said ASSIGNEE;


AND I hereby agree for myself and for my heirs, executors and administrators, to execute without further consideration any further lawful documents and any further assurances, and any provisional, non-provisional, divisional, continuing, reissue, or other applications for patents of any country, that may be deemed necessary by said ASSIGNEE fully to secure to said ASSIGNEE its interest as aforesaid in and to said invention or any part thereof, and in and to said several patents or any of them;

AND I hereby covenant for myself and my legal representatives, and agree with said ASSIGNEE, its successors and assigns, that I have granted no right or license to make, use or sell said invention, to anyone except said ASSIGNEE, that prior to the execution of this deed my right, title and interest in said invention had not been otherwise encumbered, and that I

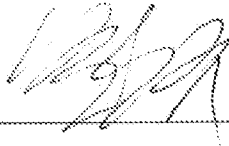
have not executed and will not execute any instrument in
conflict herewith.

IN WITNESS WHEREOF, I have hereunto set my hand.

07/27/11
Date


Won Suk LEE

07/27/11
Date


Witness